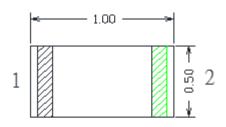
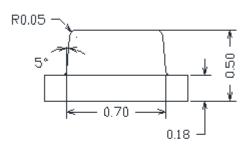
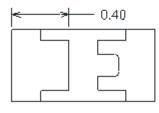


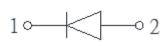
SPECIFICATION CS42C-QL4

PACKAGE OUTLINES

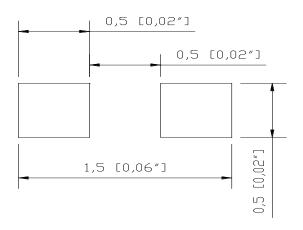








RECOMMEND PAD LAYOUT



Item	Material
Resin(Mold)	Ероху
Lens Color	Water Transparent
Dice	AlGaInP/GaAs
Emitted Color	Yellow

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CS42C-QL4	InGaAIP	Yellow	Water Clear	140°





ABSOLUTE MAXIMUM RATINGS

 $(TA=25^{\circ}C)$

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lr	10	μΑ	
Power Dissipation	Pd	75	mW	
Operating Temperature Range	Тор	-40~+80	°C	
Storage Temperature Range	Тѕтс		°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	125	mA	
Soldering Temperature	Tsol	Max 260°C for	5 sec Max	

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Darameter	Symbol	Test Condition	Value			Lloit
Parameter			Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 20mA	40	115	-	mcd
Forward Voltage	VF	IF = 20mA	-	2.0	2.5	V
Reverse Leakage Current	lr	V _R = 5V	-	10	-	μΑ
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	140	-	Deg
Peak Wavelength	λ P	IF = 20mA	1	590	-	nm
Dominant Wavelength	λD	IF = 20mA	585	590	595	nm

^{*}Tolerance of viewing angle: -10 / +5 deg.

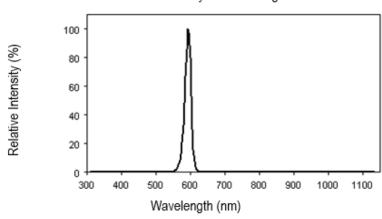




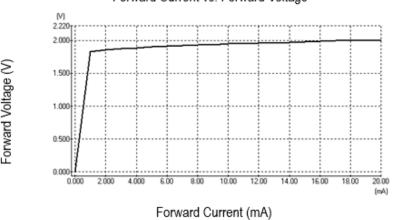
OPTICAL CHARACTERISTIC CURVES

OPTICAL CHARACTERISTIC CURVES

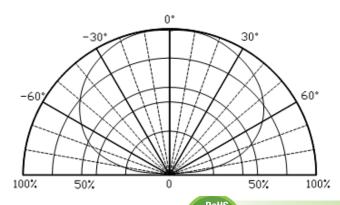
Relative Intensity vs. Wavelength



Forward Current vs. Forward Voltage



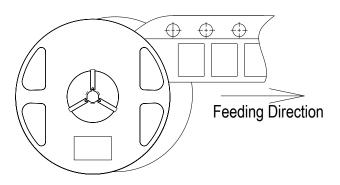
Directive Characteristics



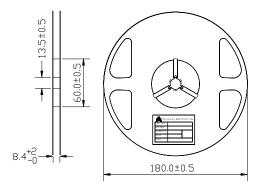


PACKAGING SPECIFICATION

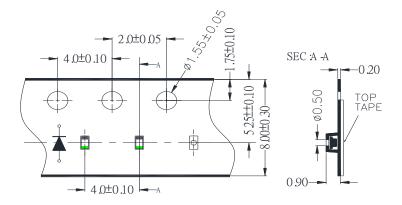
Feeding Direction



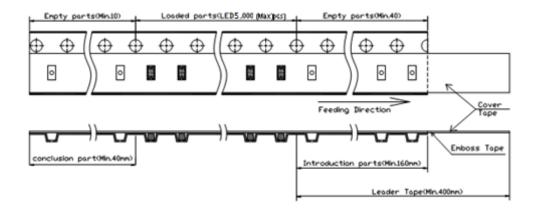
Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



Arrangement of Tape







SOLDERING CONDITIONS

SOLDERING CONDITION

- When soldering for lamp without stopper type, a minimum of 3mm clearance from the base of the lens to the soldering point must be observed.
- To avoid the epoxy climb to the lead frame and impact to non-soldering problem, dipping the lens into the solder must be avoided.
- Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.
- · Recommended soldering condition

Soldering Iron		Wave Soldering		
Temperature	300℃ Max.	Pre-heat	100℃ Max.	
Soldering Time	3 sec. Max.	Pre-heat Time	60 sec. Max.	
	(one time only)		260°C Max.	
		Soldering Time	5 sec. Max.	

- Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.
- Soldering Iron: each terminal is to go to the tip of the soldering iron temperature less than 260
 °C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals and solder each terminal. Be careful because the damage of the product is often started at the time of the hand solder.
- Repairing: repair should not be done after the LEDs have been soldered. When repairing is
 unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand
 whether the characteristics of the LEDs will or will not be damaged by repairing.

